

Features

- 1200V, 140A IGBT
- High Input Impedance
- Low Switching Losses
- Low Saturation Voltage V_{CE(SAT)}
- Copacked with Fast Recovery Diode
- Low Conduction Loss for a High Efficiency
- Rugged Transient Reliability
- Low EMI



- UPS
- EV-Charging
- String solar Inverter





Key Performance and Package Parameters

| Device | V _{CE} | I _C (T _C = 25 °C) | V _{CE(SAT)} (T _{VJ} = 25 °C, V _{GE} = 15 V) | V_F $(T_{VJ} = 25 ^{\circ}C, I_F = 40A)$ | Package | Packing |
|---------------|-----------------|--|--|--|---------|---------|
| IXYX120N120C3 | 1200V | 140A | 1.55 V | 2.01V | TO-247P | 30PCS |

Absolute Maximum Ratings (@ T_{VJ} = 25°C unless otherwise specified)

| Symbol | Parameter | | Value | Units |
|------------------|--|------------------------|-------------|-------|
| V _{CE} | Collector emitter voltage | | 1200 | V |
| | T _C | T _C = 25°C | 240 | A |
| I _C | DC collector current ⁽¹⁾ | T _C = 100°C | 140 | A |
| I _{CM} | Pulsed collector current | T _C = 25°C | 560 | A |
| | Maximum Diada famuand aumant(1) | T _C = 25°C | 240 | А |
| l _F | Maximum Diode forward current ⁽¹⁾ | T _C = 100°C | 140 | A |
| I _{FM} | Diode pulsed current | T _C = 25°C | 560 | A |
| V_{GE} | Gate-Emitter voltage | T _{VJ} = 25°C | ±20 | V |
| D | Power Dissipation | T _C = 25°C | 1091 | W |
| P _{tot} | Power Dissipation | T _C = 100°C | 545 | W |
| T _{VJ} | Operating Junction Temperature Range | | -40 to +175 | °C |
| T _{STG} | Storage Temperature Range | | -55 to +150 | °C |



Thermal Resistance

| Symbol | Parameter | Conditions | Тур | Unit |
|-----------------|---|------------|------|------|
| $R_{	heta JC}$ | IGBT Thermal resistance: junction - case | IGBT | 0.11 | °C/W |
| $R_{\theta JC}$ | Diode Thermal resistance: junction - case | Diode | 0.17 | °C/W |

Electrical Characteristics (@ T_{v1} = 25°C unless otherwise specified)

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|----------------------|--|---|------|-------|------|------|
| Static C | haracteristics | | | | • | |
| V _{(BR)CES} | Collector - Emitter Breakdown Voltage | $V_{GE} = 0V$, $I_C = 0.5mA$ | 1200 | - | - | V |
| | Collector - Emitter Saturation Voltage | V _{GE} = 15V , I _C = 140A | - | 1.55 | - | V |
| V_{CESAT} | | V _{GE} = 15V , I _C = 140A ,T _{VJ} = 175°C | - | 1.81 | - | V |
| V | Diode forward voltage | V _{GE} = 0V , I _C = 140A | - | 2.01 | - | V |
| V_{F} | | V _{GE} = 0V , I _C = 140A ,T _{VJ} = 175°C | - | 2.19 | - | V |
| $V_{GE(th)}$ | Gate-Emitter threshold voltage | $V_{GE} = V_{CE}$, $I_C = 2.24$ mA | - | 5.17 | - | V |
| I _{CES} | Zero Gate voltage Collector current | V _{CE} = 1200V , V _{GE} = 0V | - | - | 40.0 | μА |
| I _{GES} | Gate-Emitter leakage current | V _{GE} = ±20V , V _{CE} = 0V | - | - | ±100 | nA |
| Dynami | Characteristics | | | | | |
| C _{ies} | Input Capacitance | | - | 16191 | - | pF |
| C _{oes} | Output Capacitance | $V_{GE} = 0V, V_{CE} = 25V,$ f = 100k Hz | - | 407 | - | pF |
| C _{res} | Reverse Transfer Capacitance | T - 100K 112 | - | 59.4 | - | pF |
| R_G | Gate input resistance | f = 1M Hz | - | 0.8 | - | Ω |
| Q_g | Gate Charge | | - | 473 | - | nC |
| Q_{ge} | Gate to Emitter charge | $V_{GE} = 0 \text{ to } 15V$ $V_{CE} = 960V, I_{C} = 140A$ | - | 122 | - | nC |
| Q_{gc} | Gate to Collector charge | VCE - 300V, IC - 140A | - | 112 | - | nC |
| Switchir | ng Characteristics | | | | • | |
| $t_{d(on)}$ | Turn-On DelayTime | | - | 183 | - | ns |
| t _r | Turn-On Rise Time | Tvj = 25 °C V _{CC} = 600 V, I _C =140 A V _{GE} = 0 / 15 V | - | 241 | - | ns |
| $t_{d(off)}$ | Turn-Off DelayTime | | - | 359 | - | ns |
| t _f | Turn-Off Fall Time | | - | 221 | - | ns |
| E_{on} | Turn-on energy | $R_{G(on)} = 10 \Omega$, $R_{G(off)} = 10 \Omega$ | - | 11.9 | - | mJ |
| E_{off} | Turn-off energy | | - | 8.9 | - | mJ |
| E _{ts} | Total switching energy | | - | 20.8 | - | mJ |
| $t_{d(on)}$ | Turn-On DelayTime | | - | 165 | - | ns |
| t _r | Turn-On Rise Time | Tvj = 175 °C $V_{CC} = 600 \text{ V}, I_{C} = 140 \text{ A}$ $V_{GE} = 0 / 15 \text{ V}$ $R_{G(on)} = 10 \Omega, R_{G(off)} = 10 \Omega$ | - | 262 | - | ns |
| t _{d(off)} | Turn-Off DelayTime | | - | 395 | - | ns |
| t _f | Turn-Off Fall Time | | - | 274 | - | ns |
| E _{on} | Turn-on energy | | - | 12.8 | - | mJ |
| E _{off} | Turn-off energy | | - | 10.1 | - | mJ |
| E _{ts} | Total switching energy | | - | 22.9 | - | mJ |



Diode Recovery Characteristics

| T _{rr} | Reverse recovery time | Tvj = 25 °C | - | 137 | - | ns |
|------------------|-------------------------------|--|---|------|---|----|
| Q _{rr} | Reverse recovery charge | V _{CC} = 600 V, I _C =140 A | - | 0.81 | - | μС |
| I _{rrm} | Peak reverse recovery current | V _{GE} = 0 / 15 V | - | 9.3 | - | Α |
| E _{rec} | Reverse recovery energy | $R_{G(on)}$ = 10 Ω , $R_{G(off)}$ = 10 Ω | - | 9.3 | 1 | mJ |
| T _{rr} | Reverse recovery time | Tvj = 175 °C V_{CC} = 600 V, I_{C} =140 A V_{GE} = 0 / 15 V $R_{G(on)}$ = 10 Ω, $R_{G(off)}$ = 10 Ω | - | 511 | - | ns |
| Q _{rr} | Reverse recovery charge | | - | 5.4 | - | μС |
| I _{rrm} | Peak reverse recovery current | | - | 17.5 | - | А |
| E _{rec} | Reverse recovery energy | | - | 1.6 | - | mJ |

Notes: 1. Limitedby bondwire



Typical Performance Characteristics

Fig.1 Output characteristics (25°C)

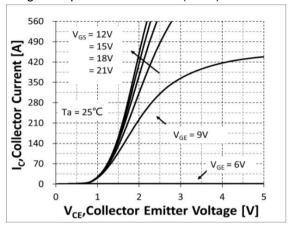


Fig.3 Safe operating area

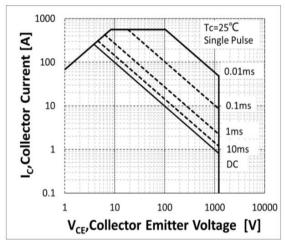


Fig.5 Gate charge

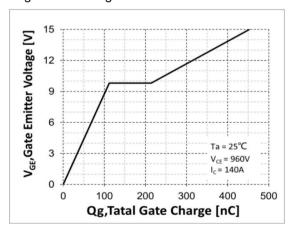


Fig.2 Output characteristics (175°C)

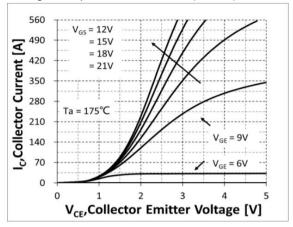


Fig.4 Transfer characteristics

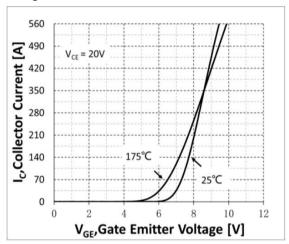


Fig.6 Typical capacitance

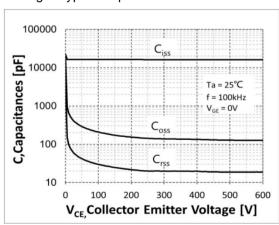




Fig.7 Switching Times vs. Gate Resistance

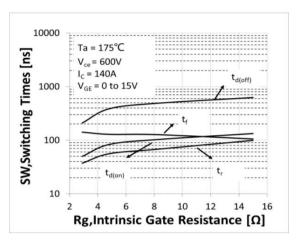


Fig.9 Switching Times vs. Collector Current

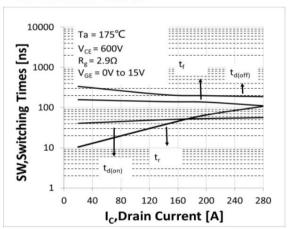


Fig.11 Switching Energy vs. Junction Temperature

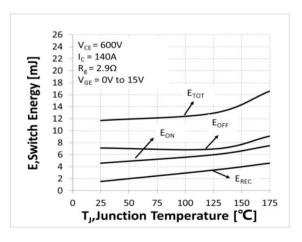


Fig.8 Switching Times vs. Junction Temperature

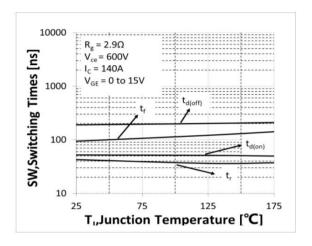


Fig.10 Switching Energy vs. Gate Resistance

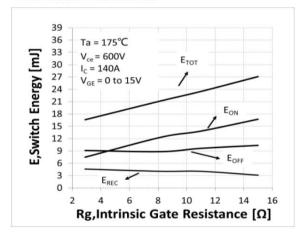


Fig.12 Switching Energy vs.Collector Current

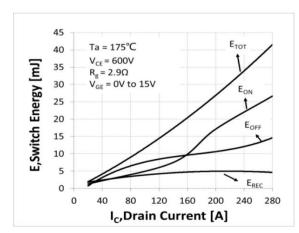


Fig.13 Switching Energy vs.Collector Emitter Voltage

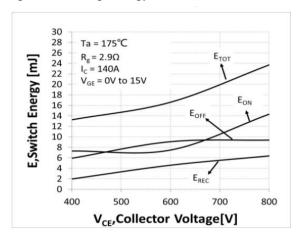


Fig.15 Gate Voltage vs. Junction Temperature

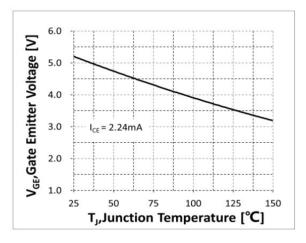


Fig.17 Thermal characteristics (IGBT)

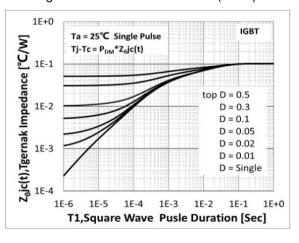


Fig.14 Saturation Voltage vs.Junction Temperature

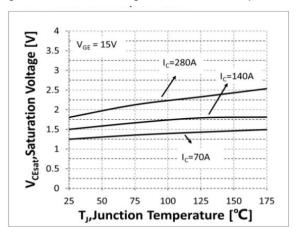


Fig.16 Body Diode Forward Voltage vs. Forward Current

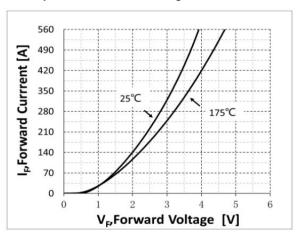
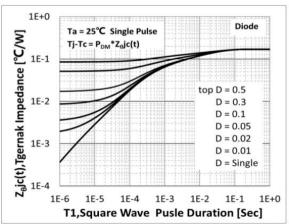
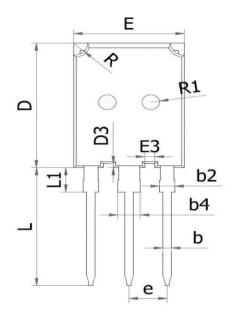


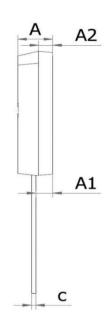
Fig.18 Thermal characteristics (Diode)

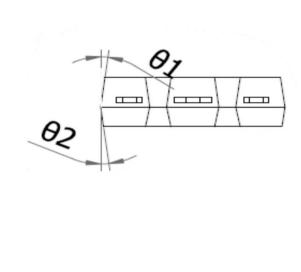


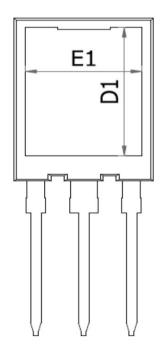


Package Mechanical Data(TO-247P)









| SYMBOL | | mm | |
|---------|-------|----------|-------|
| STWIDOL | MIN | NOM | MAX |
| A | 4.80 | 5.00 | 5.20 |
| A1 | 2.23 | 2.43 | 2.63 |
| A2 | 1.85 | 2.00 | 2.15 |
| b | 1.10 | 1.20 | 1.30 |
| b2 | 1.90 | 2.10 | 2.20 |
| b4 | 2.90 | 3.10 | 3.20 |
| С | 0.50 | 0.60 | 0.70 |
| D | 20.70 | 21.00 | 21.30 |
| D1 | 16.25 | 16.55 | 16.85 |
| D3 | 0.53 | 0.68 | 0.83 |
| E | 15.50 | 15.80 | 16.10 |
| E1 | 13.05 | 13.25 | 13.45 |
| E3 | 1.30 | 1.45 | 1.60 |
| e | > | 5.44 BSC | |
| L | 19.62 | 19.92 | 20.22 |
| L1 | | | 4.30 |
| R | 1.85 | 2.00 | 2.15 |
| R1 | 1.10 | 1.25 | 1.40 |
| θ1 | 5° | 7° | 9° |
| θ2 | 5° | 7° | 9° |



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